

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: : Docket: YOR919990336US2

Chao-kun Hu et al. : Prior Group Art Unit: 2815

Serial No.: To be Assigned : Prior Examiner: A. Wilson

Filed: Herewith : Date: November 13, 2001

For: REDUCED ELECTROMIGRATION AND STRESSED INDUCED MIGRATION
OF Cu WIRES BY SURFACE COATING

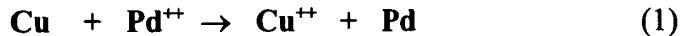
Preliminary Amendment

Commissioner for Patents
Washington, D.C. 20231

Sir:

In the Specification

Please replace Equation 1 at page 3, line 19, with the
following rewritten equation 1:



Please replace Equation 2 at page 4, line 5, with the
following rewritten equation 2:

A2 reducing agent + Meⁿ⁺ + Cu → Cu/Me + oxidized form of reducing agent (2)

Please replace Equation 3 at page 4, line 9, with the
following rewritten equation 3:

